



**IPC-9505**  
**2017 - September**

**Guideline Methodology for  
Assessing Component and  
Cleaning Materials  
Compatibility**

*An international standard developed by IPC*

*Association Connecting Electronics Industries*



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- Minimize time to market
- Contain simple (simplified) language
- Just include spec information
- Focus on end product performance
- Include a feedback system on use and problems for future improvement

**Standards Should Not:**

- Inhibit innovation
- Increase time-to-market
- Keep people out
- Increase cycle time
- Tell you how to make something
- Contain anything that cannot be defended with data

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# **Guideline Methodology for Assessing Component and Cleaning Materials Compatibility**

Developed by the Cleaning Compatibility Task Group (5-31j) of the  
Cleaning and Coating Committee (5-30) of IPC

Users of this publication are encouraged to participate in the  
development of future revisions.

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## Acknowledgment

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